





Random Phase Switching 400V Triac Driver







Description

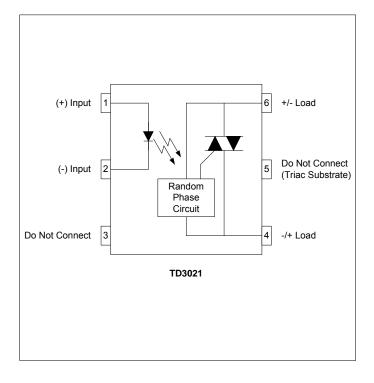
The TD3021 consists of a single input AlGaAs LED optically coupled to a Random Phase triac driver chip. The TD3021 provides high input-to-output isolation and is designed to drive high-powered triacs. Typical uses include interfacing logic level control signals to equipment powered from 110V_{AC} lines and higher.

The TD3021 comes standard in a miniature 6 pin DIP package making it ideal for high-density board applications.

Applications

- Home Appliances
- Motor / Drive Controls
- Solid State Relays
- Solenoid / Valve Controls
- Temperature Controls
- **Dimmer Controls**

Schematic Diagram



Features

- Random Phase Switching
- 400V Blocking Voltage
- Trigger Current (15mA MAX)
- High Isolation Voltage (5000V_{RMS})
- High dV/dt (1kV/μS MIN)
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

Agency Approvals

UL/C-UL: File # E201932

VDE: File # 40035191 (EN 60747-5-2)

Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

| Storage Temperature | 55 to +125°C |
|--|--------------|
| Operating Temperature | 40 to +100°C |
| Continuous Input Current | 50mA |
| Transient Input Current | 400mA |
| Reverse Input Control Voltage | 5V |
| Input Power Dissipation | 40mW |
| Output Power Dissipation | 330mW |
| Solder Temperature – Wave (10sec) | 260°C |
| Solder Temperature – IR Reflow (10sec) | 260°C |

Ordering Information

Part Number

| | · |
|------------|--|
| TD3021 | 6 pin DIP, (60/Tube) |
| TD3021-H | 0.40" (10.16mm) Lead Spacing (VDE0884) |
| TD3021-S | 6 pin SMD, (60/Tube) |
| TD3021-STR | 6 pin SMD, Tape and Reel (1000/Reel) |
| | |

Description

NOTE: Suffixes listed above are not included in marking on device for part number identification



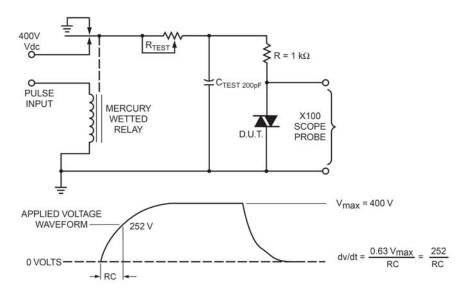
Electrical Characteristics, T_A = 25°C (unless otherwise specified)

| Parameter | Symbol | Min. | Тур. | Max. | Units | Test Conditions | |
|------------------------------------|----------------------|-------|------------------|------|------------------|--|--|
| Input Specifications | | | | | | | |
| LED Forward Voltage | V _F | - | 1.4 | 1.8 | V | I _F = 10mA | |
| LED Reverse Voltage | BV_R | 5 | - | - | V | I _R = 10μA | |
| Reverse Leakage Current | I _{InRleak} | - | - | 10 | μА | V _R = 5μA | |
| Trigger Current ¹ | I _{InOn} | - | - | 15 | mA | Main Terminal Voltage = 3V | |
| Output Specifications | <u> </u> | | | | | | |
| Blocking Voltage | V_{DRM} | 400 | - | - | V | $I_O = 1\mu A$ | |
| Peak Blocking Current | I _{DRM1} | - | 10 | 100 | nA | V _{DRM} = 400 | |
| Continuous Load Current | Io | - | - | 100 | mA | I _F = 15mA | |
| On-State Voltage | V _{ON} | - | 2 | 3 | V | I _F = 15mA, I _{TM} = 100mA | |
| Leakage Current | I _{DRM2} | - | 0.2 | 1 | μА | I _F =0mA, V _{DRM} = 400V | |
| Holding Current | I _{HOLD} | - | 250 | - | μА | - | |
| Critical Rate of Rise ² | dV/dt | 1,000 | 1,500 | - | V/µS | - | |
| Isolation Specifications | | | | | | | |
| Isolation Voltage | V _{ISO} | 5,000 | - | - | V _{RMS} | RH ≤ 50%, t=1min | |
| Input-Output Resistance | R _{I-O} | - | 10 ¹² | - | Ω | $V_{I-O} = 500V_{DC}$ | |

Note 1: Resistive load. For inductive loads, higher drive current is recommended

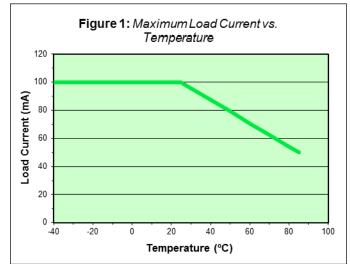
Note 2: This is for static dV/dt. Test Circuit Below

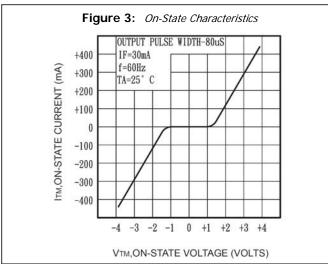
TD3021 Static dV/dt Test Circuit:

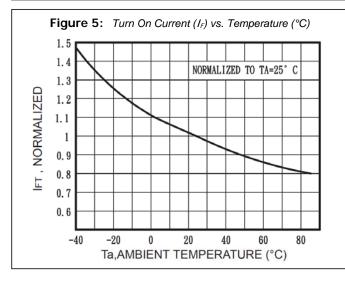


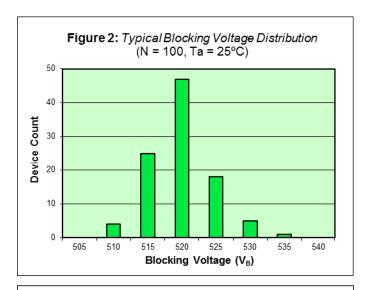


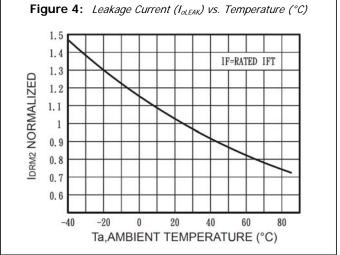
TD3021 Performance & Characteristics Plots, T_A = 25°C (unless otherwise specified)













TD3021 Solder Temperature Profile Recommendations

(1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:

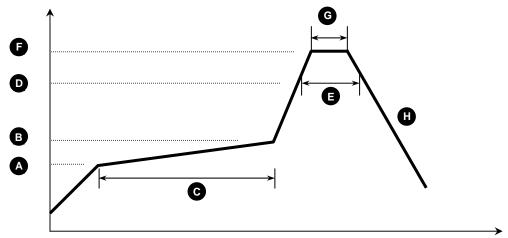


Figure 1

| Process Step | Description | Parameter | | | |
|-----------------|------------------------------------|-----------|--|--|--|
| Α | Preheat Start Temperature (°C) | 150°C | | | |
| В | Preheat Finish Temperature (°C) | 180°C | | | |
| С | Preheat Time (s) | 90 - 120s | | | |
| D | Melting Temperature (°C) | 230°C | | | |
| E | Time above Melting Temperature (s) | 30s | | | |
| F | Peak Temperature, at Terminal (°C) | 260°C | | | |
| G | Dwell Time at Peak Temperature (s) | 10s | | | |
| Н | Cool-down (°C/s) | <6°C/s | | | |

(2) Wave Solder:

Maximum Temperature: 260°C (at terminal)

Maximum Time: 10s

Pre-heating: 100 - 150°C (30 - 90s)

Single Occurrence

(3) Hand Solder:

Maximum Temperature: 350°C (at tip of soldering iron)

Maximum Time:

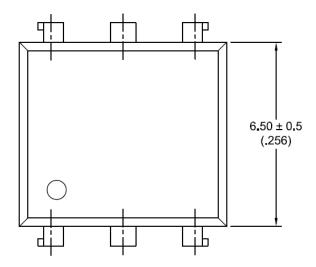
Single Occurrence

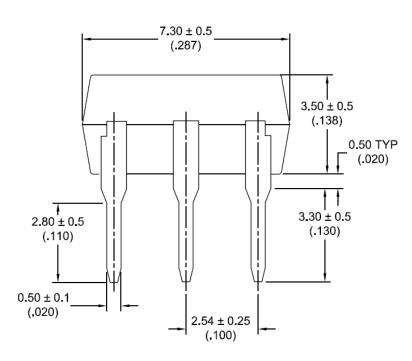
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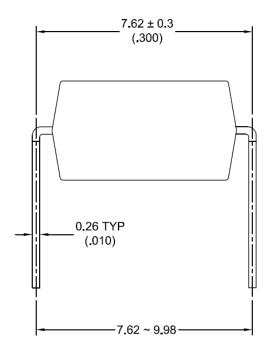


6 PIN DIP Package

Note: All dimensions in millimeters with inches ["] in parenthesis ()



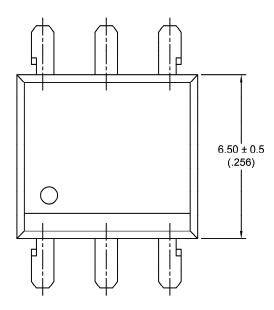


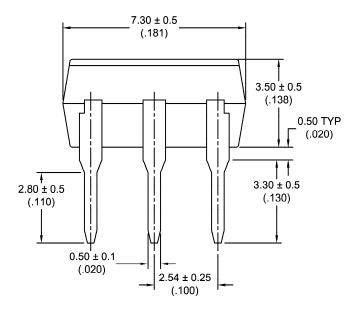


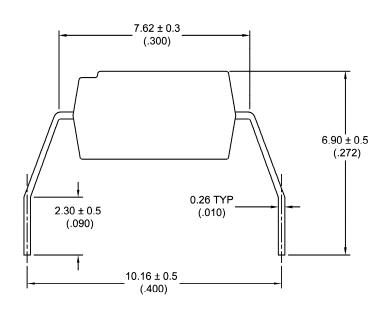


6 PIN WIDE Lead Space Package (-H)

Note: All dimensions in millimeters [mm] with inches in parenthesis ()



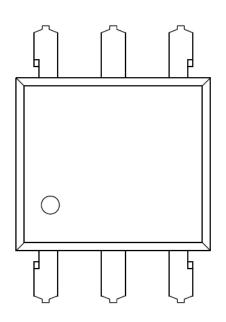


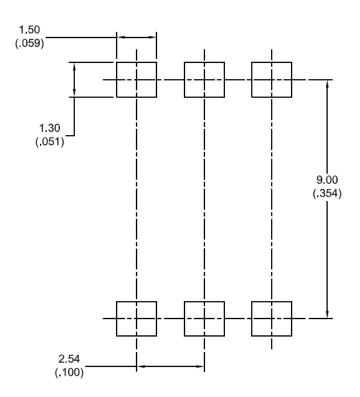


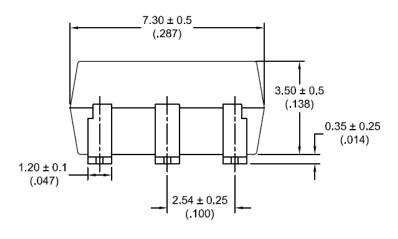


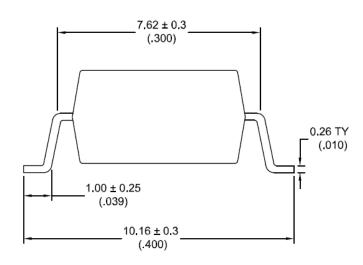
6 PIN SMD Surface Mount Package (-S)

Note: All dimensions in millimeters with inches ["] in parenthesis ()





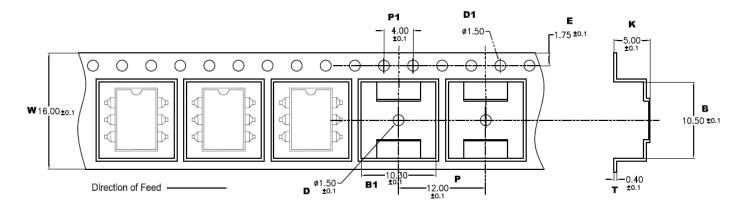




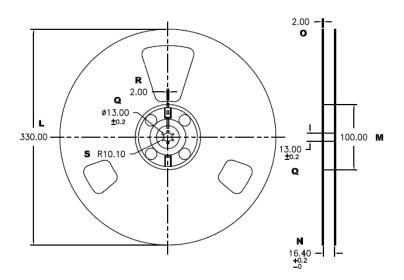


6 PIN SMD Tape & Reel (-STR)

Note: All dimensions in millimeters



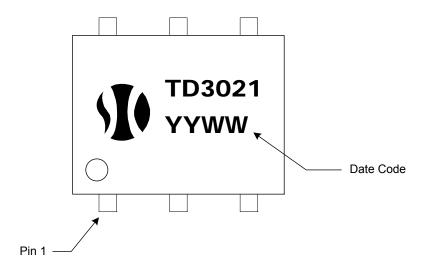
| A | В | B1 | P | P1 | K | E | T | D | D1 |
|--------------------|------------|------------|------------|-----------|-----------|-----------|-----------|-----------|-----------|
| 16.00 ± 0.1 | 10.50 ±0.1 | 10.30 ±0.1 | 12.00 ±0.1 | 4.00 ±0.1 | 5.00 ±0.1 | 1.75 ±0.1 | 0.40 ±0.1 | 1.50 ±0.1 | 1.50 ±0.1 |



| L | М | N | 0 | g | R | S |
|--------|--------|------------|-----------|------------|------|-------|
| 330.00 | 100.00 | 16.40 +0.2 | 2.00 ±0.1 | 13.00 ±0.2 | 2.00 | 10.00 |

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TD3021 Package Marking



TD3021 Package Weights

| Device | Single Unit | Full Tube (60pcs) | Full Pouch (10 tubes) | Full Reel (1000pcs) |
|------------|-------------|----------------------|--------------------------|------------------------|
| TD3021 | 0.41 | 43 | 450 | - |
| TD3021-S | 0.40 | 42 | 440 | - |
| TD3021-H | 0.42 | 44 | 460 | |
| TD3021-STR | 0.40 | - | - | 880 |

Note: All weights above are in GRAMS, and include packaging materials where applicable

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